



IITB Centre for Semiconductor Technologies

In Association With

D.Y. Patil International University, Akurdi, Pune

Presents

**A Two-Day University Affiliate Program (UAP)
Train-the-Trainer Workshop**

Semiconductor Packaging



**Date: 27th – 28th
October 2026**



**Venue: DYPIU Campus,
Akurdi, Pune**

About SemiX IITB

SemiX IIT Bombay is a national centre that supports semiconductor education, training, research, and development, aligning with the India Semiconductor Mission.

About DYPIU

DYPIU Pune's Department of Semiconductor Engineering with its pioneering semiconductor programs, aims to train students across the entire chip design and fabrication ecosystem.

What You Will Learn

- Introduction to Semiconductor Packaging
- Manufacturing/Fabrication processes in packaging
- Levels of Interconnects
- Thermal heat management
- High-density Substrates

Workshop Highlights

- Overview of Semiconductor Packaging - Role, Current trends, Hierarchy
- Industry speaker and IIT Bombay faculty
- D.Y. Patil International University's Lab Visit

Who Should Attend

- Faculty members from Mechanical, Metallurgy, Materials Science, Electronics, Electrical, Computer Science engineering and related fields.

Registration

- Registration Closes on **24 October 2026**
- Fee **Rs. 1000** per faculty participant
- Intake: **50 faculty** (First-come, first-served)

Contact

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About The Workshop

Focused faculty development program to strengthen Semiconductor Packaging concepts, importance and key manufacturing steps.

Instructors

- **Prof. Pradeep Dixit**, Professor, IIT Bombay
- **Dr. Sameer Mahajan**, Executive, SemiX-IIT Bombay
- **Industry and Keynote Speakers**

Scan to Register ↓

